

XO SPECIFICATION

Customer:	
Customer P/N:	
TKD P/N:	XO25F016000GEHE001
Part Name:	SMD XO 2520
Product Description:	16.00000MHz
Issue Date:	2023/8/8

CUSTOMER'S APPROVAL

(PLEASE RETURN A COPY WITH APPOVAL)

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Approved	Checked	Designer
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Rev.	Description of Revision History	Date	Designer	Checked By
Α	New Revision	2021/11/16	Li Yan	Zhan Chao
В	Revise Low Output Voltage	2021/11/23	Li Yan	Zhan Chao
С	Add The Product Reliability	2023/8/8	Li Yan	Wang Peng



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XO SPECIFICATION

1.Description : SMD Simple Packaged Xtal Oscillator 2520

2.Nominal Frequency : 16.000000MHz

3.Electrical Specifications

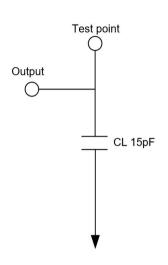
Item	Parameters	Condition -	Electrical Specifications			
пеш	Farameters		Min	Тур	Max	Units
1	Nominal Frequency		16.000000		MHz	
2	Frequency Tolerance	Note1	-25		25	ppm
3	Operating Temperature Range		-40	25	85	°C
4	Supply Voltage		3.3±10%			V
5	Current Consumption	Operating			10	mA
5	Current Consumption	Standby			10	uA
6	Output Waveform		CMOS			
7	Output Load		15			pF
8	Duty Cycle		50±10%			%
9	Output Rise/Fall Time		5		ns	
10	High Output Voltage		0.9Vdd			V
11	Low Output Voltage				0.1Vdd	V
12	Enable		Vdd*70%			V
13	Disable				Vdd*30%	V
14	Aging	Frist year	-3		3	ppm
15	Start Time				5	ms
16	Storage Temperature		-55		125	°C

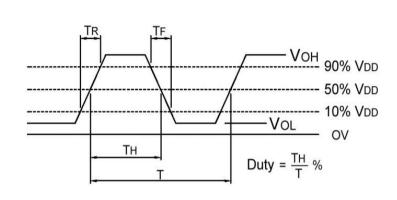
Frequency stability includes frequency tolerance@25°C and frequency stability vs. operating temperature range and voltage variance and first year aging



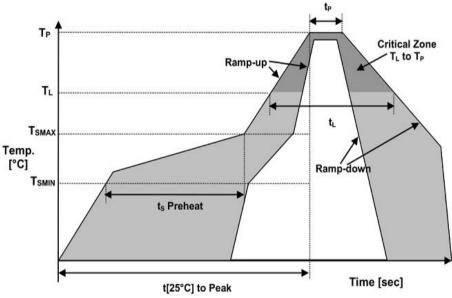
4.Test Circuit (CMOS Load)

5.Output Waveform (CMOS Load)





6.Recommended Reflow Profile

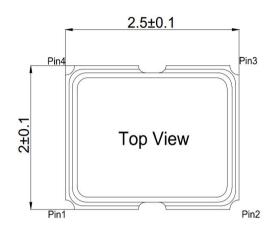


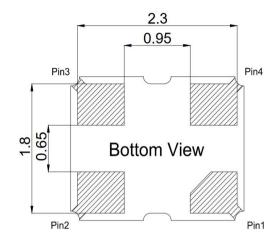
Reflow Profile				
Temperature MIN Preheat	T _{SMIN}	150°C		
Temperature MAX Preheat	T _{SMAX}	200°C		
Time (T _{SMIN} -T _{SMAX})	t _S	60-180sec		
Temperature	T _L	217°C		
Peak Temperature	T _P	260°C		
Ramp-up Rate	R _{UP}	3°C/sec max		
Ramp-Down Rate	R _{DOWN}	6°C/sec max		
Time within 5°C of Peak Temperature	t _P	10sec		
Time t(25℃) to Peak Temperature	t(25°C)to Peak	480sec		
Time	t _L	60-150sec		

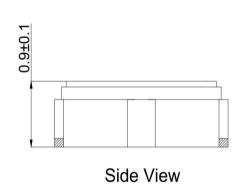


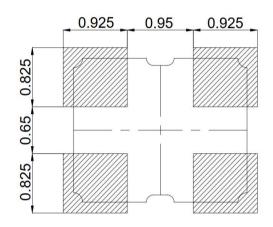
7.Product Dimensions

Unit: mm









Recommened Soldering Pattren

Pin Connection

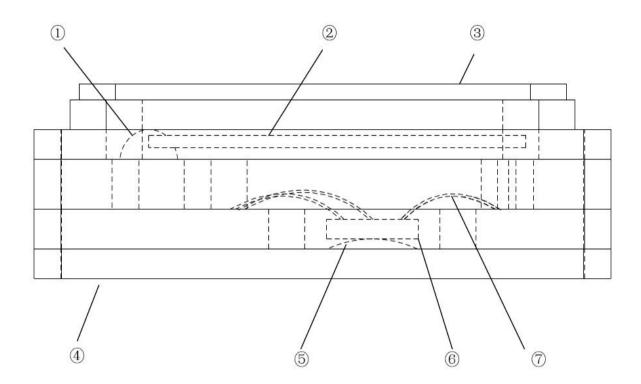
Name	Connection
pin 1	Tri-State
pin 2	GND
pin 3	Fout
pin 4	Vdd

Function

Pin1 Input	Pin3 Output	
High level	Oscillation Out	
Open	Oscillation Out	
Low level	High Z	



8.Structure illustration



No.	Components	Materials	
1	Conductive Adhesive	Ag+Silicone resin	
2	Crystal Blank	SiO ₂	
3	Lid	Fe-Ni-Co Alloy	
4	Base	Ceramic+Noble Metal	
(5)	Conductive Adhesive of Solid IC	Ag+Epoxy resin	
6	IC	Si	
7	Gold wire	Au	



9. Product Identification (Marking)

T: TKD Logo

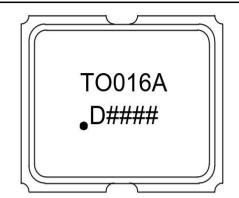
O: Oscillator Code

016A: Frequency Code

• Pin1 Index

D: Date Code

####: XO Lot Code



Date Code

Year ·		2019	2020	2021	2022
		2023	2024	2025	2026
		2027	2028	2029	2030
		2031	2032	2033	2034
	JAN	а	n	Α	N
	FEB	b	р	В	Р
	MAR	С	q	С	Q
	APR	d	r	D	R
	MAY	е	s	E	S
Month	JUN	f	t	F	Т
Month	JUL	g	u	G	U
	AUG	h	V	Н	V
	SEP	j	w	J	W
	ОСТ	k	х	К	Х
	NOV	I	у	L	Υ
	DEC	m	Z	M	Z

This date code will be cycled every four years.



10.Reliability

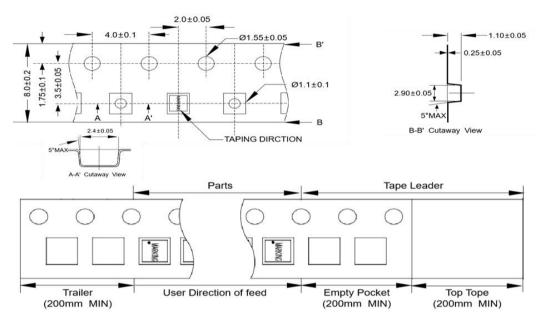
No.	Item	Test Methods	Criteria
1	Low Temperature Storage	Temperature: -40°C ± 3°C (or the specification shall prevail) Duration: 500 hours	±5.0 ppm
2	High temperature and humidity	Temperature: 85°C ± 2°C Humidity: RH 85% Duration: 500 hours	±5.0 ppm
3	Thermal Shock	$\frac{25\pm3\%}{30\pm3\text{min}}$ $\frac{25\pm3\%}{30\pm3\text{min}}$ $\frac{25\pm3\%}{30\pm3\text{min}}$ $\frac{40\pm3\%}{30\pm3\text{min}}$ $\frac{1 \text{ cycle}}{1 \text{ cycle}}$ Temperature: $-40\%\text{C} \sim 125\%$ (or the specification shall prevail) Duration: 100 cycles	±5.0 ppm
4	High Temperature Operating Life	Temperature: 85°C (or the specification shall prevail) Duration: 1000 hours Vdd Applied	±10.0 ppm
5	Vibration	Duration: 2 hours/each direction Frequency range: 10 ~ 55 Hz Direction: 3 axis	±5.0 ppm
6	Mechanical Shock	Acceleration: 100 g Duration: 6.0 ms Test cycles: 3 times for all 6 axis , half sina	±5.0 ppm
7	Drop Test	Height: 100 cm Test cycles: 3 times	±5.0 ppm
8	Solderability	Soldering bath temperature: 245°C ± 5°C Duration: 2±0.6 second	95% Coated
9	Resistance to Soldering Heat	Soldering temperature : 260°C ± 10°C Duration : 15±5 second	±5.0 ppm
10	Board Flex	Height: 3.0 mm Duration: 5 second R5 AMPLE Speed: 0.5mm/sec	±5.0 ppm



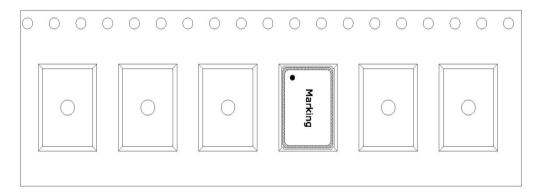
11.Package Information

Tape (Carrier) Dimensions

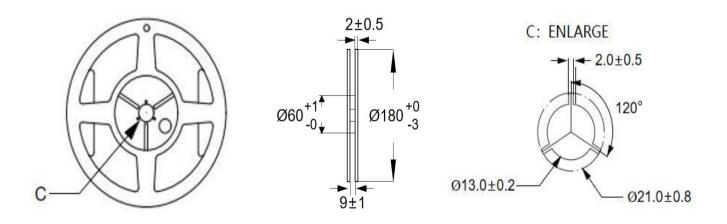
Unit: mm



The Direction of Packing



Reel Dimensions Unit: mm





Handling Instructions

1. Cautions for Handling

a) Prevention against electrostatic breakdown

Your full attention to static electricity is still requested.

b) Direction

Before mounting the crystal oscillator on board, Please confirm the direction to make sure the GND terminal and the terminal of power supply are not taken wrongly.

2. Prevention against Vibration and Shock

While the product is being transported or mounted onto board, if undue hock and vibration exceeding the specification is put on, there is risk hat the built-in crystal blank is broken. When undue shock and vibration exceeding the specification is put on the product, please be sure to make confirmation of the product's characteristics.

3. Soldering

In order to assure the reliability of the crystal oscillator, please use the product under the recommended conditions.

4. Surface mounting

- a)This product is surface-mounting device.
- So, Please pay attention to the following things.
- b)Extreme deformation of board may make pattern off, the electrode of terminals off and solder broken. Full attention is requested especially when splitting the board with the oscillator mounted where the camber of the board occurs.
- c)In case that automatic mounter is used, please choose the type with small shock generation and make confirmation of the shock before use.

5. Cleaning

Because cleaning will cause change to all characteristics, cleaning is forbidden.

6. Store keeping (method and duration)

Long-time storage in the high/low temperature and high humidity leads to deterioration of solderability. So, please keep the product in the temperature of +5~+35 and humidity of 45~70%.

Moreover, please keep the product in the circumstance with measures against static electricity.

Please use it within 168 hours afterthe pack is opened.

(Please keep it with desiccator etc. when you exceed 168 hours after the bag is opened. Please use it after confirming the product solderability.)